

WSF3087

N-Ch MOSFET

General Description

The WSF3087 is the highest performance trench N-ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The WSF3087 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

Absolute Maximum Ratings

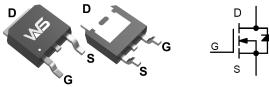
Product Summery

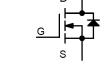
BVDSS	RDSON	ID
30V	5.0mΩ	70A

Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

TO-252 Pin Configuration





		Rating		
Symbol	Parameter	10s	Steady State	Units
V _{DS}	Drain-Source Voltage		30	V
V _{GS}	Gate-Source Voltage	<u>±</u>	20	V
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 10V ¹		70	А
I _D @T _C =100℃	Continuous Drain Current, V _{GS} @ 10V ¹		60	А
I₀@T _A =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	21	15	А
I _D @T _A =70℃	Continuous Drain Current, V _{GS} @ 10V ¹	18	11	А
I _{DM}	Pulsed Drain Current ²	150		А
EAS	Single Pulse Avalanche Energy ³ 232		mJ	
I _{AS}	Avalanche Current	41		А
P₀@T₀=25℃	Total Power Dissipation ⁴	51		W
P _D @T _A =25℃	Total Power Dissipation ⁴	6	2.0	W
T _{STG}	Storage Temperature Range	-55 to 175		°C
TJ	Operating Junction Temperature Range	-55 to 175		°C

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R _{eja}	Thermal Resistance Junction-ambient (Steady State) ¹		62	°C/W
R _{θJA}	Thermal Resistance Junction-Ambient ¹ (t ≤10s)		25	°C/W
R _{θJC}	Thermal Resistance Junction-Case ¹		2.8	°C/W



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Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V
$\triangle BV_{DSS} / \triangle T_J$	BVDSS Temperature Coefficient	Reference to 25 $^\circ\!\mathrm{C}$, I_D=1mA		0.028		V/℃
Р	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =30A		5.0	6.0	
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =4.5V , I _D =15A		8.0	9.5	mΩ
V _{GS(th)}	Gate Threshold Voltage		1.0	1.5	2.5	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, I _D =250uA		-6.16		mV/℃
	Drain Source Lookage Current	V_{DS} =24V , V_{GS} =0V , T_J =25 $^{\circ}$ C			1	
I _{DSS}	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =55℃			5	uA
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm20V$, $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =30A		43		S
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.7	3.1	Ω
Qg	Total Gate Charge (4.5V)	V _{DS} =15V , V _{GS} =4.5V , I _D =15A		20	28	
Q _{gs}	Gate-Source Charge			7.6	10.6	nC
Q _{gd}	Gate-Drain Charge			7.2	10.1	
T _{d(on)}	Turn-On Delay Time	V _{DD} =15V , V _{GS} =10V , R _G =3.3Ω I _D =15A		11	15.6	
Tr	Rise Time			15	27	
T _{d(off)}	Turn-Off Delay Time			37.3	74.6	ns
T _f	Fall Time			10.6	21.2	
Ciss	Input Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		2100		
C _{oss}	Output Capacitance			550		pF
C _{rss}	Reverse Transfer Capacitance			180		

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy⁵	V _{DD} =25V , L=0.1mH , I _{AS} =24A	55			mJ

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,6}				30	А
I _{SM}	Pulsed Source Current ^{2,6}	V _G =V _D =0V , Force Current			155	А
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25℃			1.3	V
t _{rr}	Reverse Recovery Time			25		nS
Qrr	Reverse Recovery Charge	IF=30A , dl/dt=100A/ μs , T $_{ m J}$ =25 $^\circ { m C}$		21		nC

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.

2.The data tested by pulsed , pulse width $\,\leq\,$ 300us , duty cycle $\,\leq\,$ 2%

3. The EAS data shows Max. rating . The test condition is $V_{\text{DD}}\text{=}25V, V_{\text{GS}}\text{=}10V, L\text{=}0.1\text{mH}, I_{\text{AS}}\text{=}24\text{A}$

4.The power dissipation is limited by 175 $^\circ\!\!\mathbb{C}$ junction temperature

5.The Min. value is 100% EAS tested guarantee.

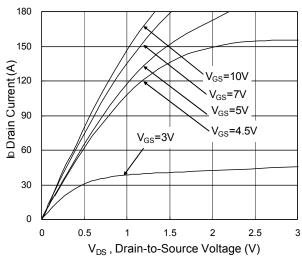
6.The data is theoretically the same as I_{D} and I_{DM} , in real applications , should be limited by total power dissipation.

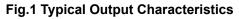


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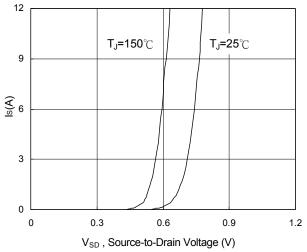


Fig.3 Forward Characteristics of Reverse

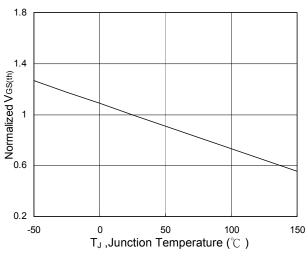


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

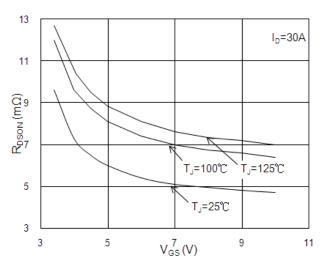


Fig.2 On-Resistance vs. G-S Voltage

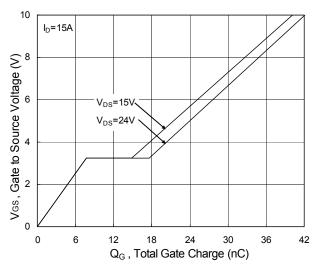


Fig.4 Gate-Charge Characteristics

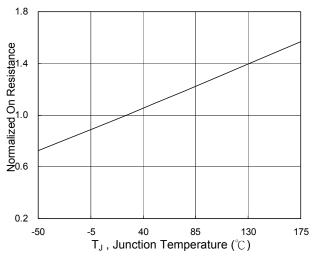


Fig.6 Normalized R_{DSON} vs. T_{J}

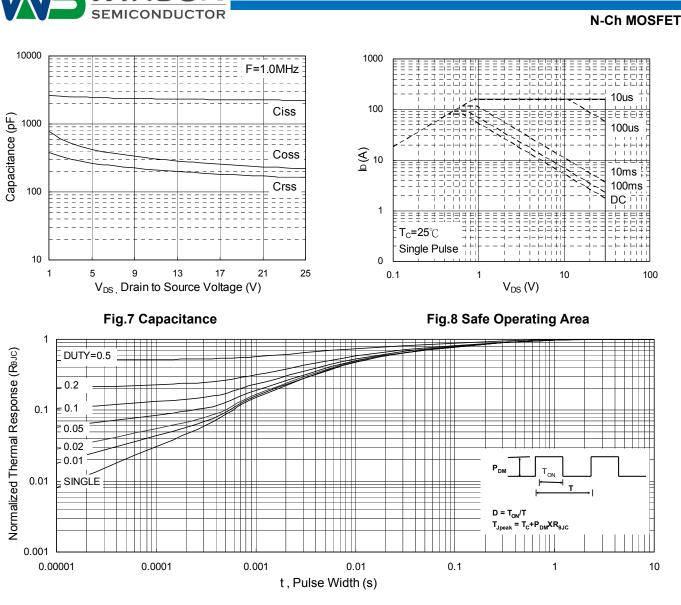
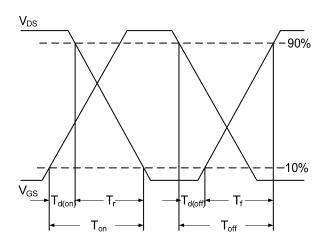


Fig.9 Normalized Maximum Transient Thermal Impedance



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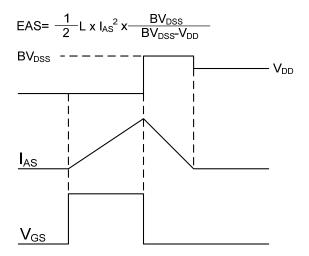


Fig.11 Unclamped Inductive Switching Waveform

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